

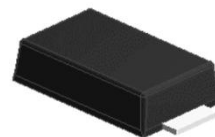
## 3A,60-100V Schottky Barrier Rectifiers

### Features

- Low leakage current
- Schottky barrier diodes
- Low forward voltage drop
- Moisture sensitivity: level 1, per J-STD-020
- Halogen-free according to IEC 61249-2-21 definition
- High temperature soldering guaranteed: 260 °C/10 seconds
- AEC-Q101 qualified



**RoHS**  
COMPLIANT



eSGB (DO-221AC)

### Applications

For use in low voltage, high frequency inverters, free-wheeling and polarity protection application.

### Maximum Ratings & Electrical Characteristics (TA=25°C unless otherwise noted)

| Parameter                                                                                    | Symbol      | ALS36       | ALS3B | Unit |
|----------------------------------------------------------------------------------------------|-------------|-------------|-------|------|
| Maximum repetitive peak reverse voltage                                                      | $V_{RRM}$   | 60          | 100   | V    |
| Maximum RMS voltage                                                                          | $V_{RMS}$   | 42          | 70    | V    |
| Maximum DC blocking voltage                                                                  | $V_{DC}$    | 60          | 100   | V    |
| Maximum average forward rectified current                                                    | $I_{F(AV)}$ | 3           |       | A    |
| Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load per diode | $I_{FSM}$   | 100         |       | A    |
| Operating junction temperature range                                                         | $T_J$       | -55 to +150 |       | °C   |
| Storage temperature range                                                                    | $T_{STG}$   | -55 to +150 |       | °C   |

### Thermal-Mechanical Specifications (TA=25°C unless otherwise noted)

| Parameter                               | Symbol          | Typ | Unit  |
|-----------------------------------------|-----------------|-----|-------|
| Thermal Resistance, Junction to Ambient | $R_{\theta JA}$ | 85  | °C /W |
| Thermal Resistance, Junction to Case    | $R_{\theta JC}$ | 15  | °C /W |
| Thermal Resistance, Junction to Lead    | $R_{\theta JL}$ | 18  | °C /W |

## Electrical Specifications (T<sub>A</sub>=25°C unless otherwise noted)

| Parameter                                       | Symbol         | Test Conditions       |                                             | Typ  | Max  | Unit |
|-------------------------------------------------|----------------|-----------------------|---------------------------------------------|------|------|------|
| Forward Drop Voltage                            | V <sub>F</sub> | ALS36                 | I <sub>F</sub> =3A<br>T <sub>A</sub> =25°C  | -    | 0.70 | V    |
|                                                 |                |                       | I <sub>F</sub> =3A<br>T <sub>A</sub> =125°C | 0.55 | -    |      |
|                                                 |                | ALS3B                 | I <sub>F</sub> =3A<br>T <sub>A</sub> =25°C  | -    | 0.80 |      |
|                                                 |                |                       | I <sub>F</sub> =3A<br>T <sub>A</sub> =125°C | 0.60 | -    |      |
| Maximum reverse leakage current @V <sub>R</sub> | I <sub>R</sub> | T <sub>J</sub> =25°C  |                                             | 0.5  |      | mA   |
|                                                 |                | T <sub>J</sub> =125°C |                                             | 100  |      |      |
| Typical junction capacitance                    | C <sub>J</sub> | 4.0 V<br>1 MHZ        |                                             | 234  |      | pF   |

### Note:

1. Mounted on copper pad area of 0.2x0.2" (5.0 x 5.0mm) to each terminal.

## Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)

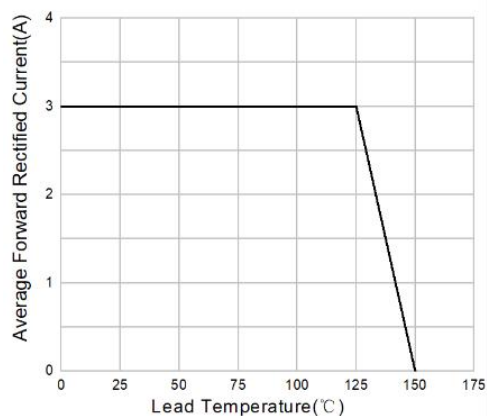


Figure 1. Forward Current Derating Curve

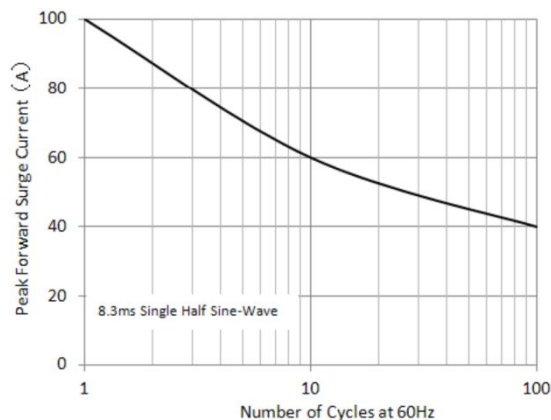


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

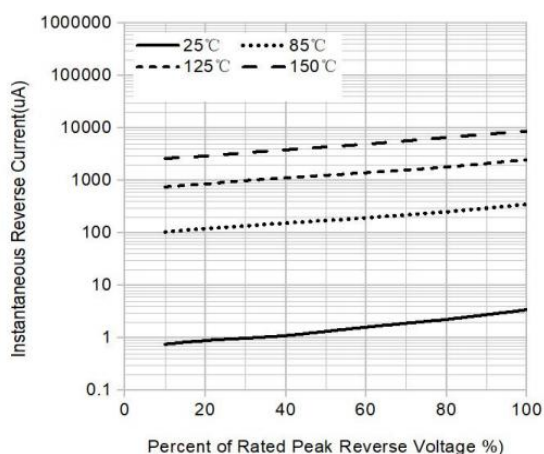


Figure 3. Typical Reverse Characteristics

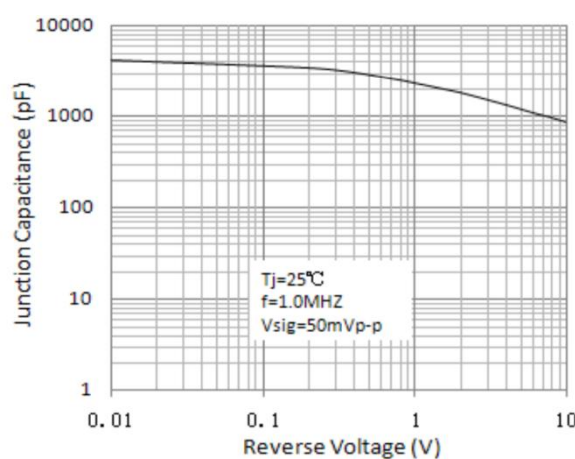


Figure 4. Typical Junction Capacitance

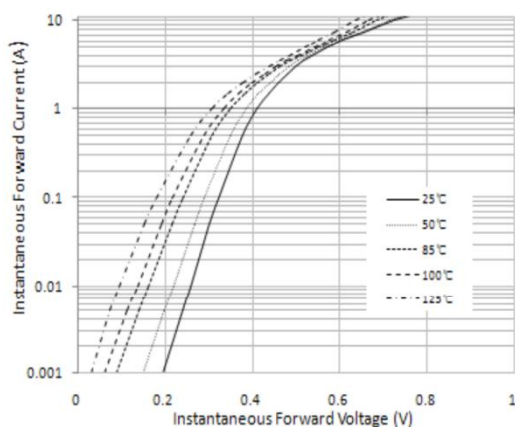
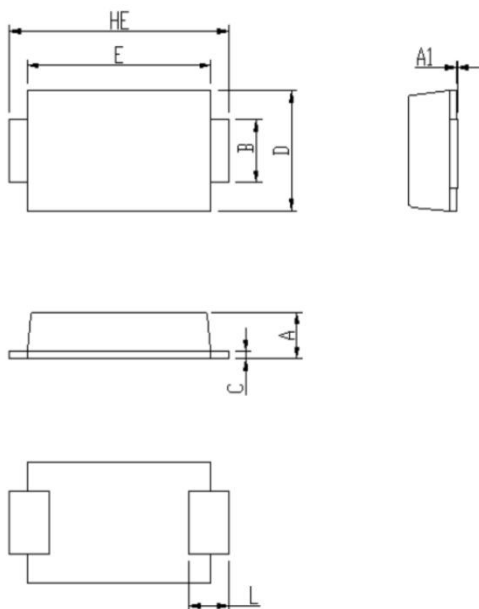


Figure 5. Typical Instantaneous Forward Characteristics

## Package Outline Dimensions

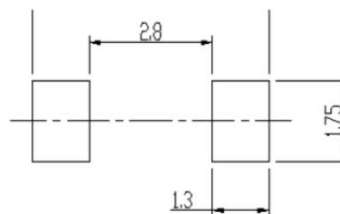
in inches (millimeters)

### eSGB (DO-221AC)



| DIM | Unit: mm |      | Unit: inch |       |
|-----|----------|------|------------|-------|
|     | MIN      | MAX  | MIN        | MAX   |
| A   | 0.92     | 1.08 | 0.036      | 0.043 |
| A1  | 0        | 0.1  | 0.000      | 0.004 |
| B   | 1.25     | 1.45 | 0.049      | 0.057 |
| C   | 0.1      | 0.25 | 0.004      | 0.010 |
| D   | 2.6      | 2.8  | 0.102      | 0.110 |
| E   | 4.1      | 4.3  | 0.161      | 0.169 |
| L   | 0.7      | 1.1  | 0.028      | 0.043 |
| HE  | 4.8      | 5.2  | 0.189      | 0.205 |

Soldering footprint



## Revision History

| Document Version | Date of release | Description of changes |
|------------------|-----------------|------------------------|
| Rev.A            | 2025.10.27      | Released Datasheet     |

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